

SST-10-IRD-940nm

Dual Junction Surface Mount Series

Infrared LED

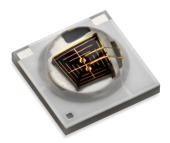


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Features

- High Power Infrared LED with typical 940nm centroid wavelength
- 50, 90 and 130-degree viewing angle
- Operation at up to 1.5A CW and 5A pulse
- Built-in ESD protection
- Low Thermal Resistance
- Suitable for all SMT Assembly Methods
- RoHS and REACh compliant

Applications

- Surveillance Systems / CCTV
- Iris and Face Recognition
- License Plate Scanning
- Automotive Sensing
- Machine Vision
- Night Vision



Technology Overview

Luminus SST-10-IRD-940nm LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

Reliability

Luminus SST-10-IRD-940nm LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity. They are fully qualified for use in a wide range of high performance and high efficacy applications.

REACh & RoHS Compliance

The Luminus SST-10-IRD-940nm LED is compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used.

Understanding Luminus SST-10-IRD-940nm LED Test Specifications

Every Luminus LED is fully tested to ensure it meets the high quality standards customers have come to expect from Luminus products.

Testing Temperature

Luminus SST-10-IRD-940nm LEDs are tested and binned at 25°C junction temperature. Temperature curves are provided to allow users to scale the data for actual operating temperature conditions.



Product Ordering and Shipping Part Number Nomenclature

All SST-10-IRD-940nm products are packaged and labeled with part numbers as outlined in below. When shipped, each reel will contain only a single flux wavelength and Vf bin. The part number designation is as follows:

Products	Ordering Part Number	Description
SST-10-IRD	SST-10-IRD-B##-F###	SST-10 dual junction surface mount infrared LED

SST	<u> </u>	СС	 B##	— F###

Product Family	Chip Area	Color	Package Configuration	Bin Kit ^{1,2}
SST - Ceramic Surface Mount package w/ encapsulation	10: 1.0 mm ²	IRD = Dual Junction Infrared	B50 - 50 deg Beam Angle B90 - 90 deg Beam Angle B130 - 130 deg Beam Angle Ceramic 3.45mm x 3.45mm See Pages 8-10 for Detailed Drawings	See below for flux and wavelength binning informa- tion

Peak Wavelength	Minimum Flux Bin (mW)	Lens Angle	Ordering Part Number
	475	50	SST-10-IRD-B50-S940
940	475	90	SST-10-IRD-B90-S940
	475	130	SST-10-IRD-B130-S940

Flux Bins¹

Bin Code	Radiometric Power	at 350mA, t _p =20ms
Bin Code	Minimum Flux (mW)	Maximum Flux (mW)
S	475	505
Т	505	535
U	535	565
V	565	595

Wavelength Bins¹

Bin Code Minimum Peak Wavelength (nm)		Maximum Peak Wavelength (nm)
940	930	970



Optical and Electrical Characteristics¹

Devenueter	Gumehal	Р	ackage Typ	be	l la it
Parameter	Symbol	B50	B90	B130	Unit
Forward Current	I _f		350		mA
Output Power Typical	РО		535		mW
Output Power at 1.0A, t =20ms (typ.)	PO _{1.0A}		1,470		mW
Radiant Intensity at 1.0A, t_=20ms (typ.)	ϕ_e	1270	770	410	mW/sr
Minimum Forward Voltage ¹	V_{fmin}		2.6		V
Forward Voltage Typical	V _f		2.8		V
Maximum Forward Voltage ¹	V _{f max}		3.2		V
Viewing Angle	2Ø _{1/2}	50	90	130	deg
Peak Wavelength Typical	$\lambda_{_{P}}$		950		nm
Centroid Wavelength Typical	λ	940			nm
FWHM Typical	Δλ _{1/2}		30		nm
Temperature Coefficient of Foward voltage	TC _V ,		-3.0		mV/ ℃
Temperature Coefficient of Radiometric Power	TC _{PO}	-0.2			%/°C
Temperature Coefficient of Wavelength	ΤϹ	0.3			nm/ °C
Thermal Resistance (Electrical)	R _{TH}		5.3		°C/W

Note 1: Binning based on operation at a current of 350mA, 20ms single pulse and a constant junction temperature of $T_j = 25$ °C. Parts are binned and shipped in 0.2V V fincrements.

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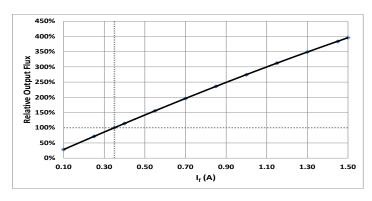
Absolute Maximum Ratings²

Parameter	Symbol	Rating	Unit
Forward Current ^{3,4}	I	1.5	A
Power Dissipation	PD	6	W
Reverse Voltage	VR	5	V
Storage Temperature	Тятд	-40~100	°C
Junction Temperature ^{3,4}	ΤJ	115 ℃	°C
Soldering Temperature	Tsld	JEDEC 020 , 260 °C	
ESD Sensitivity (HBM)	VB	6000	V

Note 2: To prevent damage refer to operating conditions and derating curves for appropriate maximum operating conditions

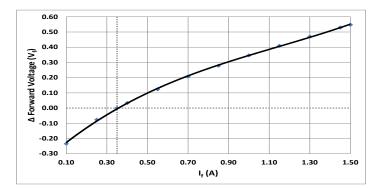
- Note 3: Luminus SST-10-IRD-940nm LEDs *ar*e designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.
- Note 4: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please operate devices within specified conditions.
- Note 5: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.



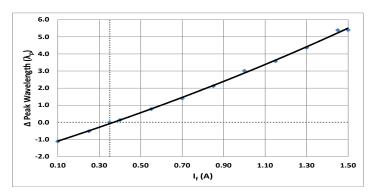


Relative Output Flux vs. Forward Current

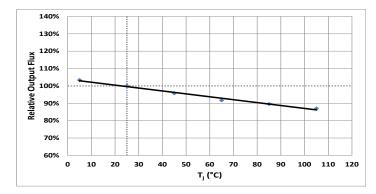
Relative Forward Voltage vs. Forward Current



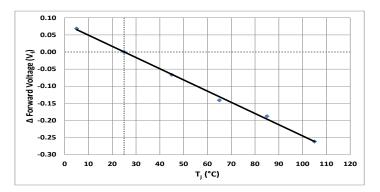
Relative Peak Wavelength vs. Forward Current



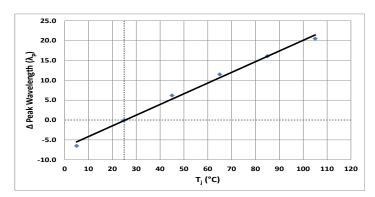
Relative Output Flux vs. Temperature



Relative Forward Voltage vs. Temperature



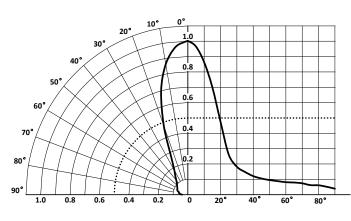
Relative Peak Wavelength vs. Temperature



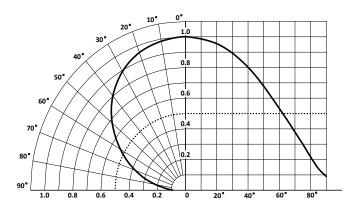
6



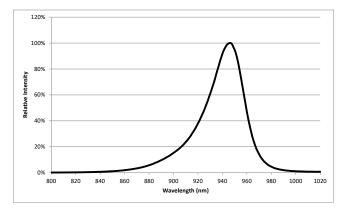
Typical Polar Radiation Plot - B50



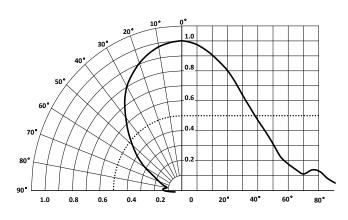
Typical Polar Radiation Plot - B130



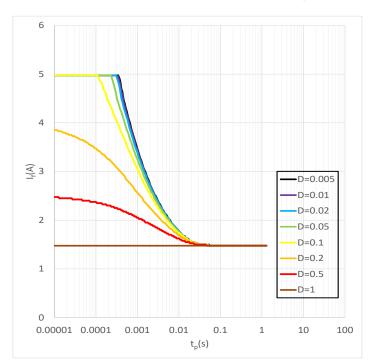
Typical Spectrum



Typical Polar Radiation Plot - B90



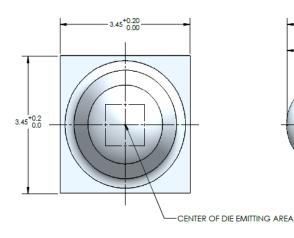
Permissible Pulse Handling Capability

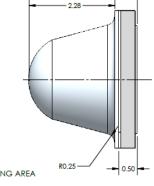


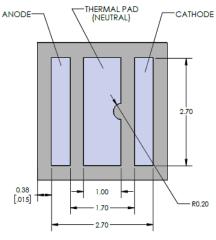


Mechanical Dimensions - B50 Package

2.87±0.10



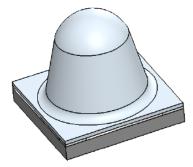


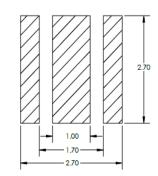


FRONT VIEW

SIDE VIEW

BACK VIEW

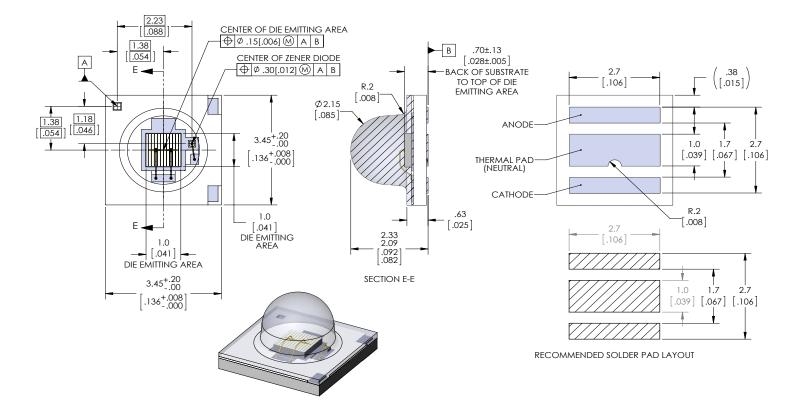




Recommended PCB Solder Pad

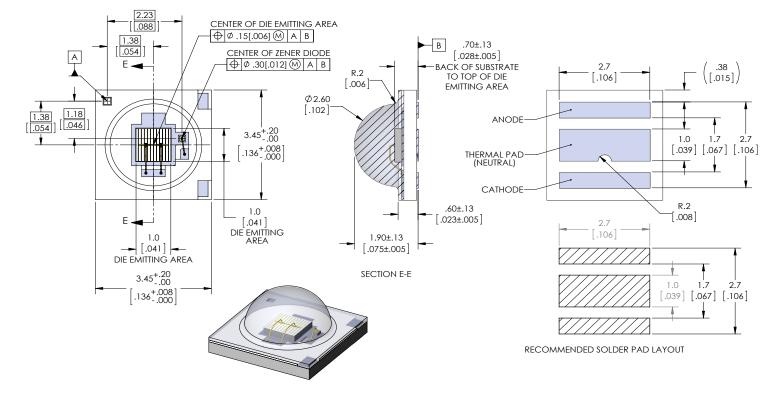


Mechanical Dimensions - B90 Package



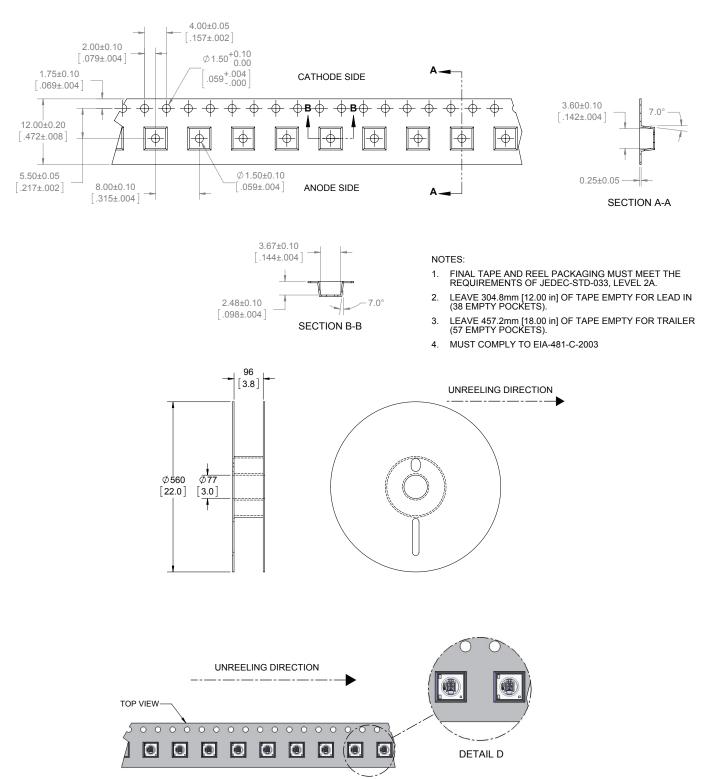


Mechanical Dimensions - B130 Package



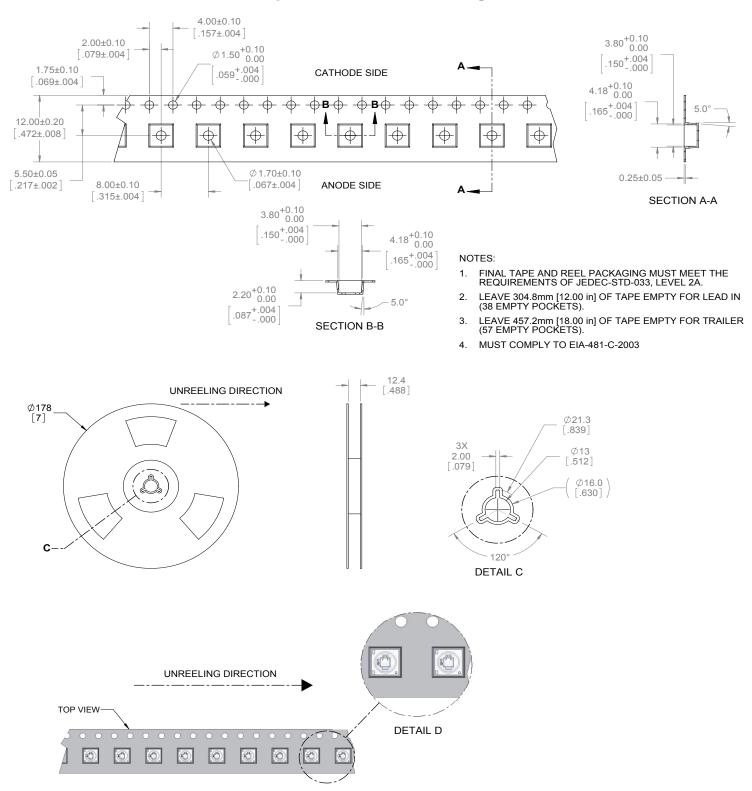


Tape and Reel - B50 and B90 Packages





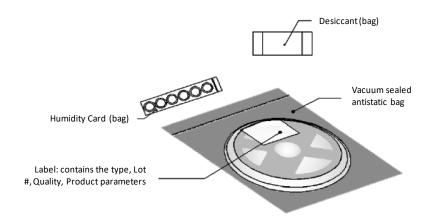
Tape and Reel - B130 Package





Reel Packaging

500 parts per reel for B50/B90 Packages - 1,000 parts per rel for B130 Package

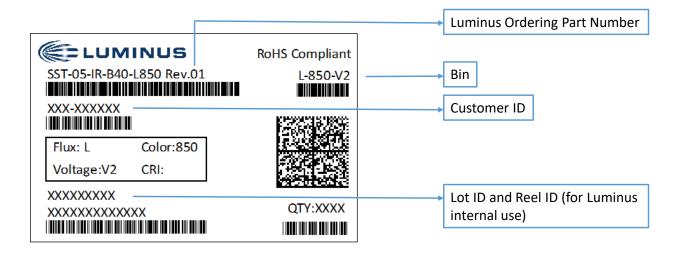


Reel Label

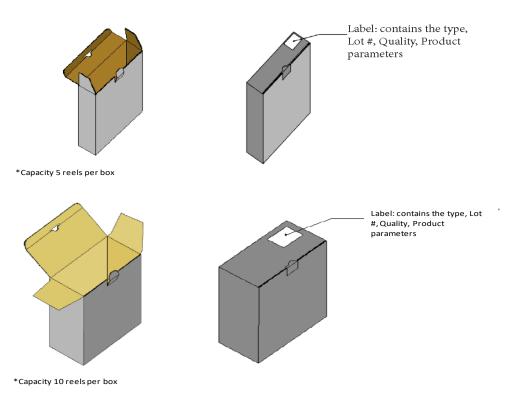
		Luminus Internal Part Number
LUMINUS 113407 Rev.01 L-850-V2	RoHS Compliant	Bin
SST-05-IR-B40	E222363800	Customer Part Number Root
Flux: LColor:850Voltage:V2CRI:		
	QTY:500	Lot ID and Reel ID (for Luminus internal use)



Shipping Label



Box Packaging Information



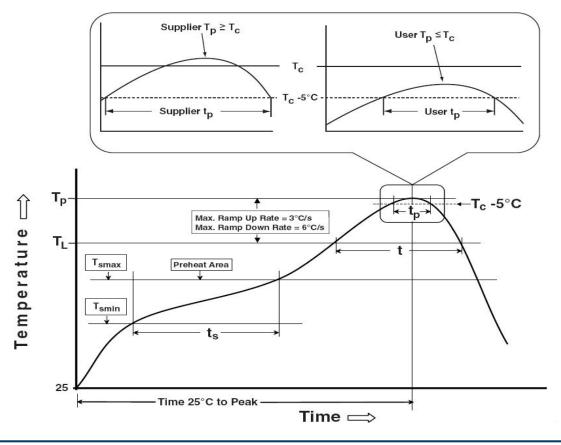


Soldering Profile

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	100 ℃ 150 ℃ 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3 °C/second max	3 °C/second max
Liquidous temperature (TL) Time at liquidous (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	230 ℃ ~235 ℃	255 °C ~260 °C
Classification temperature (Tc)	235 ℃	260 °C
Time (tp) within 5 °C of the specified classification temperature (Tc)	20 seconds	30 seconds
Average ramp-down rate (Tp to Tsmax)	6 °C/second max	6 °C/second max
Time 25 °C to peak temperature	6 minutes max	8 minutes max

* Tolerance for peak profile temperature(Tp) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature(tp) is defined as a supplier minimum and a user maximum.





Precautions for Use

Storage:

1. Before opening the package

The LEDs should be kept at <40 & <90%RH. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

2. After opening the package

The LEDs should be kept at \leq 30 & \leq 60%RH. The LEDs should be soldered within 168 hours (7days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions : 60 °C for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

Static Electricity:

1. The products are sensitive to static electricity, and care should be taken when handling them.

2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear a anti-electrostatic wristband or an anti-electrostatic gloves when handling the LEDs.

3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.



History of Changes

Rev	Date	Description of Change
01	12/30/2018	Initial Release

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